

Hyperstone F2-16X

32-Bit Flash Memory Controller Specification

PRELIMINARY



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1. Features

1.1. Host interface

- ❑ PCMCIA 2.1 and PC Card ATA standard compatible
- ❑ Memory mapped or I/O operation
- ❑ Fast ATA host-to-buffer transfer rates supporting PIO 4 in True-IDE mode
- ❑ Automatic sensing of PCMCIA or True-IDE host interface mode
- ❑ Dual integrated 512 Byte PCMCIA Sector Buffers and 256 Byte PCMCIA Attribute Memory
- ❑ PCMCIA Configuration Option Register, Card Configuration and Status Register and Pin Replacement Register support

1.2. Flash Memory Interface

- ❑ Supports all control signal for serial type flash memory connection
- ❑ Supports direct connection of up to 16 (F2-16XN) or 10 (F2-16XT) flash memory chips
- ❑ Supports 64, 256m 512Mbit Hitachi (AND) type flash memories
- ❑ Supports 32, 64, 128, 256, 512Mbit, 1, 2Gbit Samsung (NAND) type flash memories
- ❑ Flash memory power down logic and flash memory write protect control
- ❑ Firmware storage in flash memory
- ❑ Firmware is loaded into internal memory by the boot ROM
- ❑ Error Correcting Code capable of correcting 6 bytes in a 512 byte sector
- ❑ On-chip voltage regulator for 3.3V flash memory power supply
- ❑ On-chip voltage regulator for 2.5V processor core power supply

1.3. Controller Core

- ❑ High performance microprocessor core based on the Hyperstone architecture
- ❑ Clock frequency 20MHz or 40MHz using R-C oscillator
- ❑ 8 Kbyte Internal Boot ROM
- ❑ 16 Kbyte internal RAM
- ❑ Automatic power-down mode during wait periods for host data or flash memory operation completion
- ❑ Automatic sleep mode during host inactivity periods, $I_{cc} < 200 \mu A$
- ❑ 128 pin LQFP (14×14×1.4 mm, F2-16XN), 100 pin TQFP (14×14×1.0 mm, F2-16XT)
- ❑ 0.25 μm CMOS technology
- ❑ Supply voltage 5.0V $\pm 10\%$ or 3.3V $\pm 5\%$

2. General Description

The **Hyperstone** F2-16XN and F2-16XT flash memory controllers are among the most powerful single-chip controllers on the market for designing ATA based Flash Memory PC Cards / CompactFlash Cards. The required external component count is reduced to a bare minimum of few passive components enabling the design of very low-cost but high-performance ATA flash memory cards / CompactFlash Cards.

The **Hyperstone** F2-16X flash memory controller can operate with flash memory devices from Hitachi and Samsung or compatible chips thereof. It operates with 5.0V and 3.3V and enables automatic voltage detection for the cards. A highly sophisticated Error Correction Code and a wear-leveling algorithm are also implemented. A complete set of development tools is available which enables you to design ATA Flash Memory Cards / CompactFlash Cards with a very competitive cost/performance ratio.

The main features of **Hyperstone** F2-16X flash memory controller are:

- ☐ Inexpensive single-chip controller for ATA flash memory cards / CompactFlash cards
- ☐ Full support for Hitachi (AND) and Samsung (NAND) flash memories
- ☐ Built-in 3.3V voltage regulator for flash memory supply
- ☐ Built-in 2.5V voltage regulator for processor core supply
- ☐ Built-in PC card / CompactFlash Interface
- ☐ Data transfer rate to flash memories: up to 20 MBytes/s
- ☐ Supports True-IDE mode
- ☐ On-chip ECC unit
- ☐ Sophisticated software for wear leveling
- ☐ Automatic power-down mode and sleep mode
- ☐ Small 128-pin LQFP package (F2-16XN)
- ☐ available in a 100-pin TQFP package (F2-16XT) for low-cost CompactFlash Card applications supporting up to 10 flash memory chips
- ☐ Comprehensive equipment available for development and test of hardware and firmware

The **Hyperstone** F2-16X single-chip controller for ATA Flash Memory Cards / CompactFlash Cards is based on the **Hyperstone** E1-32X microprocessor core providing a modern 32-bit RISC architecture. The controller's flash memory interface allows the direct connection of up to 16 flash memory chips (10 chips for the F2-16XT) and supports either Hitachi 64, 256, 512 Mbit flash memories (e.g. HN29W6411) or Samsung type flash memories (32 Mbit to 2 Gbit). Next-generation flash memories will be supported as well. Through the sophisticated memory interface of the **Hyperstone** F2-16X, your flash memory card will achieve a superior performance with a data transfer rate to flash memories of up to 20 MBytes/s. An on-chip ECC unit generates the required code bytes for error detection and correction of up to six bytes per 512 Byte data sector. Code byte generation during write operations as well as error detection during read operation is implemented on the fly without any speed penalties.

The controller is equipped with 16 KByte internal memory that is used for storage of code and data. The internal memory can also be used as an intermediate memory for storing data blocks during a wear-leveling procedure.

The **Hyperstone** F2-16X controller works at power supply voltages of 5.0V as well as 3.3V. It provides a built-in voltage regulator of 3.3V to supply flash memories with the required voltage even when the interface from the host offers just a voltage of 5.0V.

An 8 KByte internal boot ROM includes basic routines for accessing the flash memories and for loading the main code into the internal memory of the **Hyperstone** F2-16X. This boot concept offers a high degree of flexibility while keeping the component count small.

The PC Card / CompactFlash interface provides all required signals and is fully compliant with the PC Card standard Rel. 2.1. The PC Card controller part of the **Hyperstone** F2-16X includes 256 Byte attribute memory, PCMCIA configuration and status registers, two 512 Byte sector buffers and the complete ATA register set. Optionally, the controller can be operated in True-IDE mode.

A comprehensive tool kit is also available for developing and testing ATA Flash Memory Cards / CompactFlash Cards based on **Hyperstone** F2-16X. This includes a HW/SW test environment, pre-format HW/SW, Firmware for ECC and wear leveling.

3. Pin Configuration

3.1. *hyperstone* F2-16XN, 128-Pin Package

3.1.1. Pin Configuration - View from Top Side

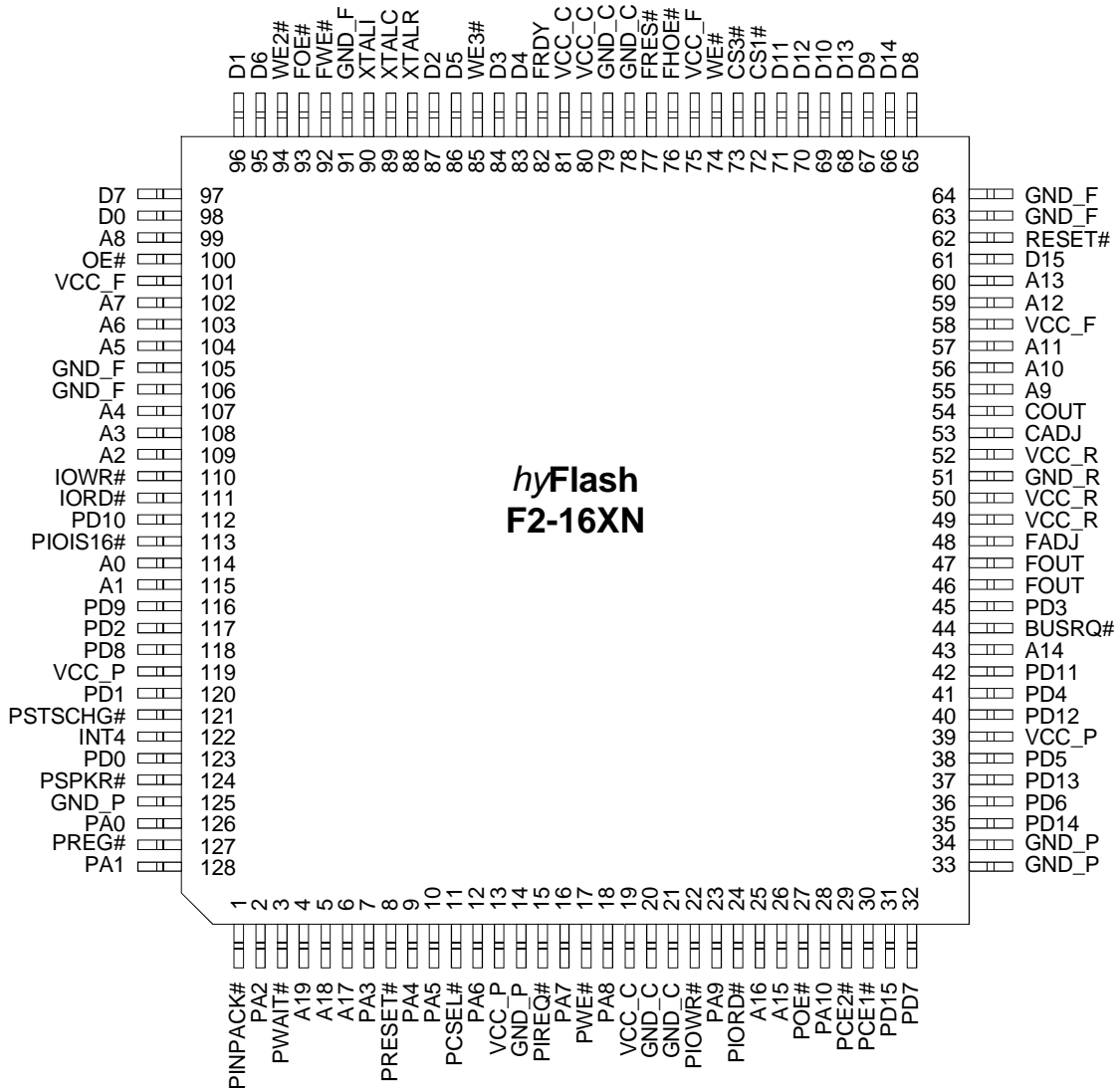


Figure 1: *Hyperstone* F2-16XN, 128 Pin LQFP Package

3.1.2. Pin Cross Reference by Pin Name

Signal	Location	Signal	Location	Signal	Location	Signal	Location
A0.....	114	D15	61	IORD#.....	111	PD9.....	116
A1.....	115	D2	87	IOWR#.....	110	PINPACK#	1
A10.....	56	D3	84	OE#.....	100	PIOIS16#	113
A11.....	57	D4	83	PA0	126	PIORD#	24
A12.....	59	D5	86	PA1	128	PIOWR#	22
A13.....	60	D6	95	PA10	28	PIREQ#.....	15
A14.....	43	D7	97	PA2	2	POE#	27
A15.....	26	D8	65	PA3	7	PREG#.....	127
A16.....	25	D9	67	PA4	9	PRESET#	8
A17.....	6	FADJ	48	PA5	10	PSPKR#.....	124
A18.....	5	FHOE#	76	PA6	12	PSTSCHG#	121
A19.....	4	FOE#.....	93	PA7	16	PWE#.....	17
A2.....	109	FOUT	46	PA8	18	PWAIT#	3
A3.....	108	FOUT	47	PA9	23	RESET#.....	62
A4.....	107	FRDY	82	PCE1#.....	30	VCC_C.....	19
A5.....	104	FRES#	77	PCE2#.....	29	VCC_C.....	80
A6.....	103	FEW#.....	92	PCSEL#	11	VCC_C.....	81
A7.....	102	GND_C	20	PD0.....	123	VCC_F.....	58
A8.....	99	GND_C	21	PD1	120	VCC_F	75
A9.....	55	GND_C	78	PD10.....	112	VCC_F	101
BUSRQ#	44	GND_C	79	PD11	42	VCC_P.....	13
CADJ.....	53	GND_F.....	63	PD12.....	40	VCC_P.....	39
COUT	54	GND_F.....	64	PD13.....	37	VCC_P.....	119
CS1#	72	GND_F.....	91	PD14.....	35	VCC_R.....	49
CS3#	73	GND_F.....	105	PD15.....	31	VCC_R.....	50
D0.....	98	GND_F.....	106	PD2	117	VCC_R.....	52
D1.....	96	GND_P.....	14	PD3.....	45	WE#	74
D10.....	69	GND_P.....	33	PD4.....	41	WE2#	94
D11.....	71	GND_P.....	34	PD5.....	38	WE3#	85
D12.....	70	GND_P.....	125	PD6.....	36	XTALC	89
D13.....	68	GND_R	51	PD7	32	XTALI	90
D14.....	66	INT4	122	PD8.....	118	XTALR	88

3.1.3. Pin Cross Reference by Location

Location	Signal	Location	Signal	Location	Signal	Location	Signal
1	PINPACK#	33	GND_P	65	D8	97	D7
2	PA2	34	GND_P	66	D14	98	D0
3	PWIT#	35	PD14	67	D9	99	A8
4	A19	36	PD6	68	D13	100	OE#
5	A18	37	PD13	69	D10	101	VCC_F
6	A17	38	PD5	70	D12	102	A7
7	PA3	39	VCC_P	71	D11	103	A6
8	PRESET#	40	PD12	72	CS1#	104	A5
9	PA4	41	PD4	73	CS3#	105	GND_F
10	PA5	42	PD11	74	WE#	106	GND_F
11	PCSEL#	43	A14	75	VCC_F	107	A4
12	PA6	44	BUSRQ#	76	FHOE#	108	A3
13	VCC_P	45	PD3	77	FRES#	109	A2
14	GND_P	46	FOUT	78	GND_C	110	IOWR#
15	PIREQ#	47	FOUT	79	GND_C	111	IORD#
16	PA7	48	FADJ	80	VCC_C	112	PD10
17	PWE#	49	VCC_R	81	VCC_C	113	PIOIS16#
18	PA8	50	VCC_R	82	FRDY	114	A0
19	VCC_C	51	GND_R	83	D4	115	A1
20	GND_C	52	VCC_R	84	D3	116	PD9
21	GND_C	53	CADJ	85	WE3#	117	PD2
22	PIOWR#	54	COOUT	86	D5	118	PD8
23	PA9	55	A9	87	D2	119	VCC_P
24	PIORD#	56	A10	88	XTALR	120	PD1
25	A16	57	A11	89	XTALC	121	PSTSCHG#
26	A15	58	VCC_F	90	XTALI	122	INT4
27	POE#	59	A12	91	GND_F	123	PD0
28	PA10	60	A13	92	FWE#	124	PSPKR#
29	PCE2#	61	D15	93	FOE#	125	GND_P
30	PCE1#	62	RESET#	94	WE2#	126	PA0
31	PD15	63	GND_F	95	D6	127	PREG#
32	PD7	64	GND_F	96	D1	128	PA1

3.2. *hyperstone* F2-16XT, 100-Pin Package

3.2.1. Pin Configuration - View from Top Side

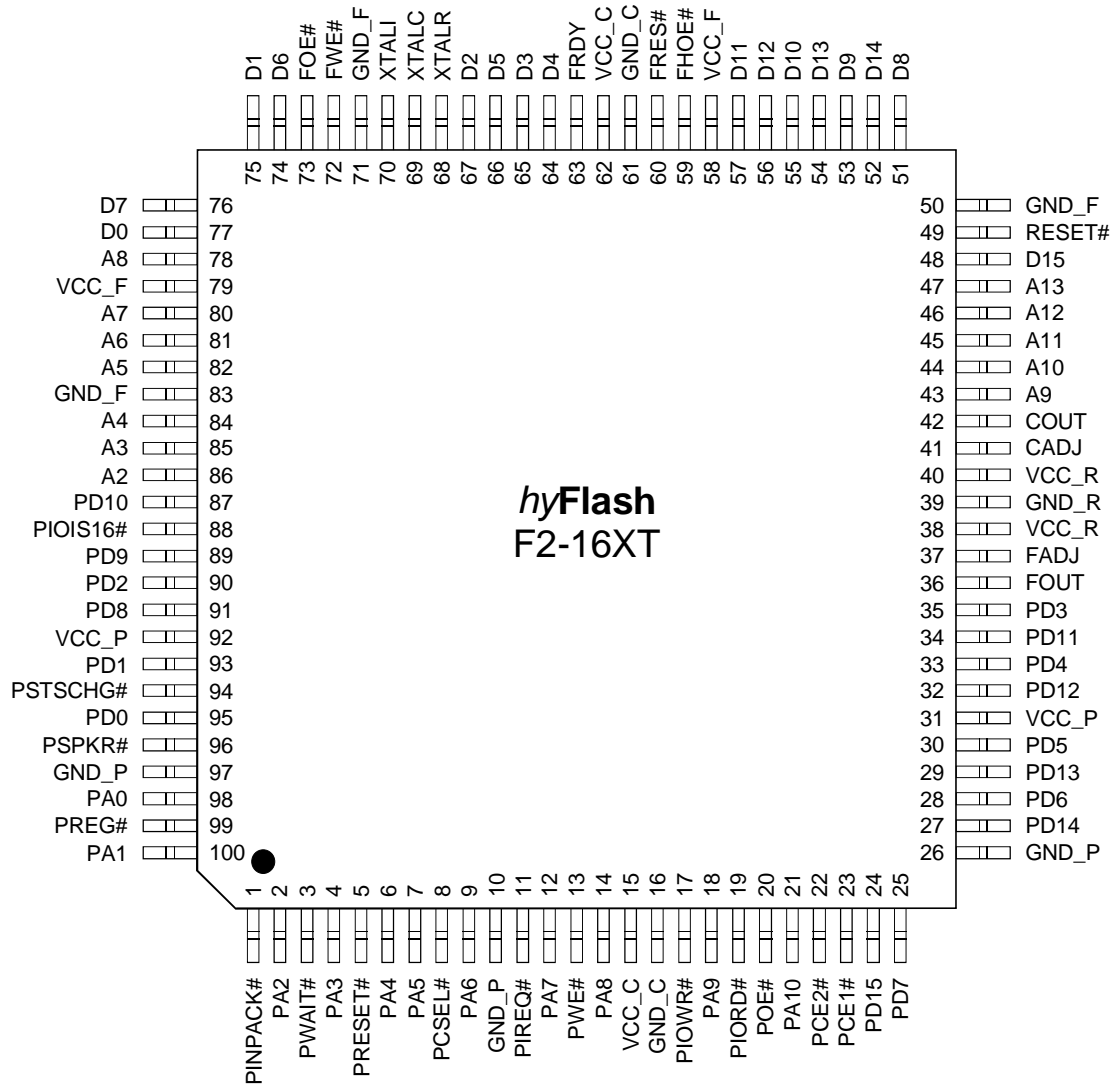


Figure 2: *Hyperstone* F2-16XT, 100 Pin TQFP Package

3.2.2. Pin Cross Reference by Pin Name

Signal	Location	Signal	Location	Signal	Location	Signal	Location
A10.....	44	D5	66	PA3	4	PD9.....	89
A11.....	45	D6	74	PA4	6	PINPACK#	1
A12.....	46	D7	76	PA5	7	PIOIS16#	88
A13.....	47	D8	51	PA6	9	PIORD#	19
A2.....	86	D9	53	PA7	12	PIOWR#	17
A3.....	85	FADJ.....	37	PA8	14	PIREQ#.....	11
A4.....	84	FHOE#.....	59	PA9	18	POE#	20
A5.....	82	FOE#.....	73	PCE1#	23	PREG#.....	99
A6.....	81	FOUT	36	PCE2#	22	PRESET#	5
A7.....	80	FRDY	63	PCSEL#	8	PSPKR#.....	96
A8.....	78	FRES#	60	PD0.....	95	PSTSCHG#	94
A9.....	43	FWE#.....	72	PD1.....	93	PWAIT#	3
CADJ.....	41	GND_C	16	PD10.....	87	PWE#	13
COUT.....	42	GND_C	61	PD11.....	34	RESET#.....	49
D0	77	GND_F.....	50	PD12.....	32	VCC_C.....	15
D1	75	GND_F.....	71	PD13.....	29	VCC_C.....	62
D10	55	GND_F.....	83	PD14.....	27	VCC_F.....	58
D11	57	GND_P.....	10	PD15.....	24	VCC_F.....	79
D12	56	GND_P.....	26	PD2.....	90	VCC_P.....	31
D13	54	GND_P.....	97	PD3.....	35	VCC_P.....	92
D14	52	GND_R.....	39	PD4.....	33	VCC_R.....	38
D15	48	PA0	98	PD5.....	30	VCC_R.....	40
D2	67	PA1	100	PD6.....	28	XTALC	69
D3	65	PA10	21	PD7.....	25	XTALI.....	70
D4	64	PA2	2	PD8.....	91	XTALR	68

3.2.3. Pin Cross Reference by Location

Location	Signal	Location	Signal	Location	Signal	Location	Signal
1	PINPACK#	26	GND_P	51	D8	76	D7
2	PA2	27	PD14	52	D14	77	D0
3	PWAIT#	28	PD6	53	D9	78	A8
4	PA3	29	PD13	54	D13	79	VCC_F
5	PRESET#	30	PD5	55	D10	80	A7
6	PA4	31	VCC_P	56	D12	81	A6
7	PA5	32	PD12	57	D11	82	A5
8	PCSEL#	33	PD4	58	VCC_F	83	GND_F
9	PA6	34	PD11	59	FHOE#	84	A4
10	GND_P	35	PD3	60	FRES#	85	A3
11	PIREQ#	36	FOUT	61	GND_C	86	A2
12	PA7	37	FADJ	62	VCC_C	87	PD10
13	PWE#	38	VCC_R	63	FRDY	88	PIOIS16#
14	PA8	39	GND_R	64	D4	89	PD9
15	VCC_C	40	VCC_R	65	D3	90	PD2
16	GND_C	41	CADJ	66	D5	91	PD8
17	PIOWR#	42	COUT	67	D2	92	VCC_P
18	PA9	43	A9	68	XTALR	93	PD1
19	PIORD#	44	A10	69	XTALC	94	PSTSCHG#
20	POE#	45	A11	70	XTALI	95	PD0
21	PA10	46	A12	71	GND_F	96	PSPKR#
22	PCE2#	47	A13	72	FWE#	97	GND_P
23	PCE1#	48	D15	73	FOE#	98	PA0
24	PD15	49	RESET#	74	D6	99	PREG#
25	PD7	50	GND_F	75	D1	100	PA1

3.3. Package Dimensions

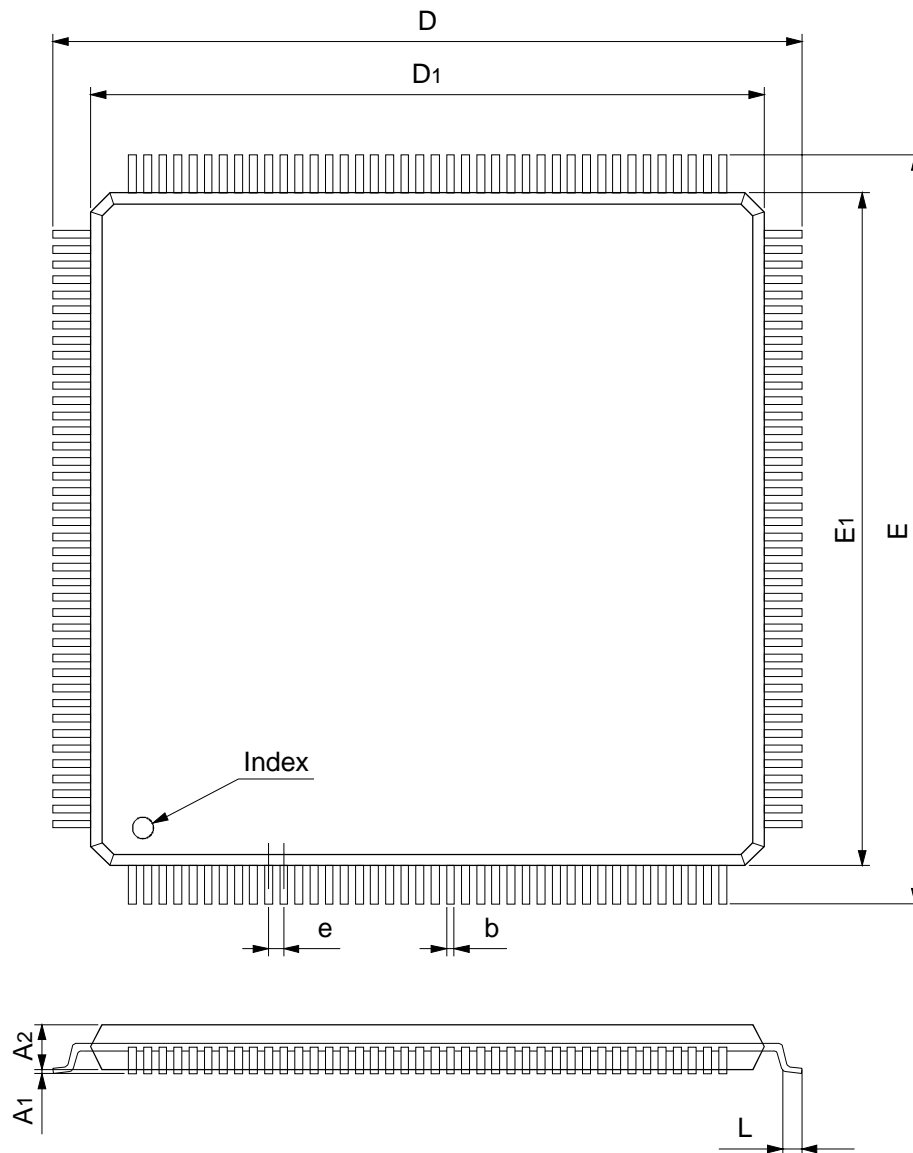


Figure 3: *Hyperstone* F2-16X Package Outline

Symbol	Term	Definition
A1	Standoff height	Height from ground plane to bottom edge of package
A2	Package height	Height of package itself
E, D	Overall length & width	Length and width including leads
E1, D1	Package length & width	Length and width of package
L	Lead footprint	Length of flat lead section
e	Lead pitch	Lead pitch
B	Lead width	Width of a lead

Hyperstone F2-16XN, 128 Pin LQFP Package

Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max
A1	0.05	0.10	0.15	.002	.004	.006
A2	1.35	1.40	1.45	.053	.055	.057
E, D	15.80	16.00	16.20	.622	.630	.638
E1, D1	13.00	14.00	14.10	.547	.551	.555
L	0.45	0.60	0.75	.018	.024	.030
B	0.13	0.18	0.23	.005	.007	.009
e		0.40			.0157	

Hyperstone F2-16XT, 100 Pin TQFP Package

Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max
A1	0.05	0.10	0.15	.002	.004	.006
A2	0.95	1.00	1.05	.037	.039	.041
E, D	15.80	16.00	16.20	.622	.630	.638
E1, D1	13.00	14.00	14.10	.547	.551	.555
L	0.45	0.60	0.75	.018	.024	.030
B	0.17	0.22	0.27	.007	.009	.011
e		0.50			.0197	

3.4. Bus Signals

3.4.1. Bus Signals for the F2-16X Flash Memory Controller

The following table is an overview of the bus signals of the *Hyperstone* F2-16X flash memory controller. The signal states are defined as I = input, O = output, pu = pull-up, pd = pull-down, h = hold and s = strong.

Status	Pins F2-16XN	Pins F2-16XT	Signal Name	Description
Flash Memory Control				
O	1	1	FWE#	Samsung/Hitachi Write Enable
O	1	1	FOE#/FSC	Samsung Output Enable, Hitachi Clock
I/pu/s	1	1	FRDY	Flash Ready/Busy (E1-32X IO1)
O/pd	1	1	FRES#	Flash Reset/Write Protect (E1-32X IO2)
O/pu	1	1	FHOE#	Hitachi Output Enable (E1-32X IO3)
Flash Memory and Core Voltage Supply				
O	1	1	FOUT	3.3V Flash Power Supply Output
I	1	1	FADJ	External Resistor for 3.3V Voltage Adjustment
I	1	1	COUT	2.5V Core Power Supply Output
I	1	1	CADJ	External Resistor for 2.5V Voltage Adjustment
PC Card Interface				
I/pu	1	1	PCE1#	Card Enable 1
I/pu	1	1	PCE2#	Card Enable 2
I/h	1	1	PREG#	Attribute Memory or I/O Enable
I/pu	1	1	PWE#	Memory Write Enable, Service Mode
I/pu	1	1	POE#	Memory Output Enable, True-IDE Mode Select
I/pu	1	1	PIOWR#	I/O Write Enable
I/pu	1	1	PIORD#	I/O Read Enable
I/pu	1	1	PCSEL#	True-IDE Chip Select
I/h	1	1	PRESET	Reset Signal
I/h	11	11	PA(10..0)	Address Bus
I/O/h	16	16	PD(15..0)	Data Bus
O	1	1	PIOIS16#	Write Protect / 16-bit I/O Transfer
O	1	1	PINPACK#	Input Acknowledge
O/pu	1	1	PIREQ#	Ready/Busy / Interrupt Request
O/pu	1	1	PSTSCHG#	Status Change / True-IDE DIAG
O/pu	1	1	PSPKR#	Speaker / DMA Request / True-IDE DASP
O/pu	1	1	PWAIT#	Wait Signal

States	Pins F2-16XN	Pins F2-16XT	Signal Name	Description
General Control				
O	8	-	A(19..14,1..0)	Address Bus
O	12	12	A(13..2)	Address Bus
I/O	16	16	D(15..0)	Data Bus
O	1	-	BUSRQ#	Multiple Controller Bus Request
O	1	-	CS3#	Chip Select for MEM3 (for Debug)
O	1	-	CS1#	Chip Select for MEM1 (for Debug)
O	2	-	WE2#, WE3#	SRAM Write Byte Enable (for Debug)
O	1	-	WE#	SRAM Write Enable (for Debug)
O	1	-	OE#	Output Enable (for Debug)
O	1	-	IOWR#	I/O Write Enable (for Debug)
O	1	-	IORD#	I/O Read Enable (for Debug)
I/pd	1	-	INT4	Interrupt 4, Boot Select ROM / MEM3 (for Debug)
I	1	1	RESET#	Reset
R-C Oscillator				
I	1	1	XTALI	Input
O	1	1	XTALC	Capacitor
O	1	1	XTALR	Resistor
Power Supply				
	2	1	VCC_R	Power Supply Voltage, Regulator
	3	2	VCC_P	Power Supply Voltage, PCMCIA Bus
	4	3	VCC_F	Power Supply Voltage, Flash Memory
	3	2	VCC_C	Power Supply Voltage, Core
	2	1	GND_R	Ground, Regulator
	4	3	GND_P	Ground, PCMCIA Bus
	5	3	GND_F	Ground, Flash Memory
	4	2	GND_C	Ground, Core

Total: 128 100

Table 1: Bus Signals for the F2-16X Flash Memory Controller

3.4.2. Bus Signal Description

The following section describes the bus signals for both the *Hyperstone* F2-16X controller in detail. In the following signal description, the signal states are defined as I = input, O = output, U = pull-up, D = pull-down.

I	XTALI	R/C Clock Oscillator Input. This input connects to the other side of the resistors and the capacitor connected to XTALR1, XTALR2 and XTALC. Connect a 22pF capacitor from this pin to ground.
O	XTALC	R/C Clock Oscillator Capacitor Output. Connect a 22pF capacitor between this pin and XTALI.
O	XTALR1	R/C Clock Oscillator Resistor Output. The resistor connected between this pin and XTALI determines the operating clock frequency. Use a 470Ω resistor to obtain a frequency of about 20 MHz.
O	A19..A0	<p>The address bits A19..A0 represent the address bus. An active high bit signals a "one". A0 is the least significant bit. The address pins are used as chip select signals for up to 12 Flash memory chips and to address an external SRAM or ROM memory. The A19..A14 and A1..A0 signals are not available on the F2-16XT.</p> <p>Address bits A13..A9 can be used as Flash memory "Ready" interrupt inputs by enabling this functionality in FCR if they are not used as chip select outputs.</p>
O/I	D15..D0	<p>Data bus. The signals D15..D0 represent the bidirectional data bus; active high signals a "one".</p> <p>At a read access, data is transferred from the data bus to the register set or to the instruction cache only at the cycle corresponding to the last actual read access cycle, thus inhibiting garbled data from being transferred.</p> <p>At a write access, the data bus signals are activated during the address setup, write and bus hold cycle(s).</p> <p>If byte wide Flash memory chips are used, they are connected to the D0..D7 data lines.</p>
O	BUSRQ#	Multiple Controller Bus Request. This pin is used for the communication between multiple controllers connected to the PCMCIA bus.
O	CS1#, CS3#	Chip Select. Chip select is signaled in the same cycle(s) as the address signals. Active low of CS1# or CS3# indicates chip select for the memory areas MEM1 (SRAM) and MEM3 (ROM) respectively. These signals are not available on the F2-16XT.
O	WE#	SRAM Write Enable. Active low indicates a write access to SRAM. This signal is not available on the F2-16XT.

3.4.2. Bus Signal Description (continued)

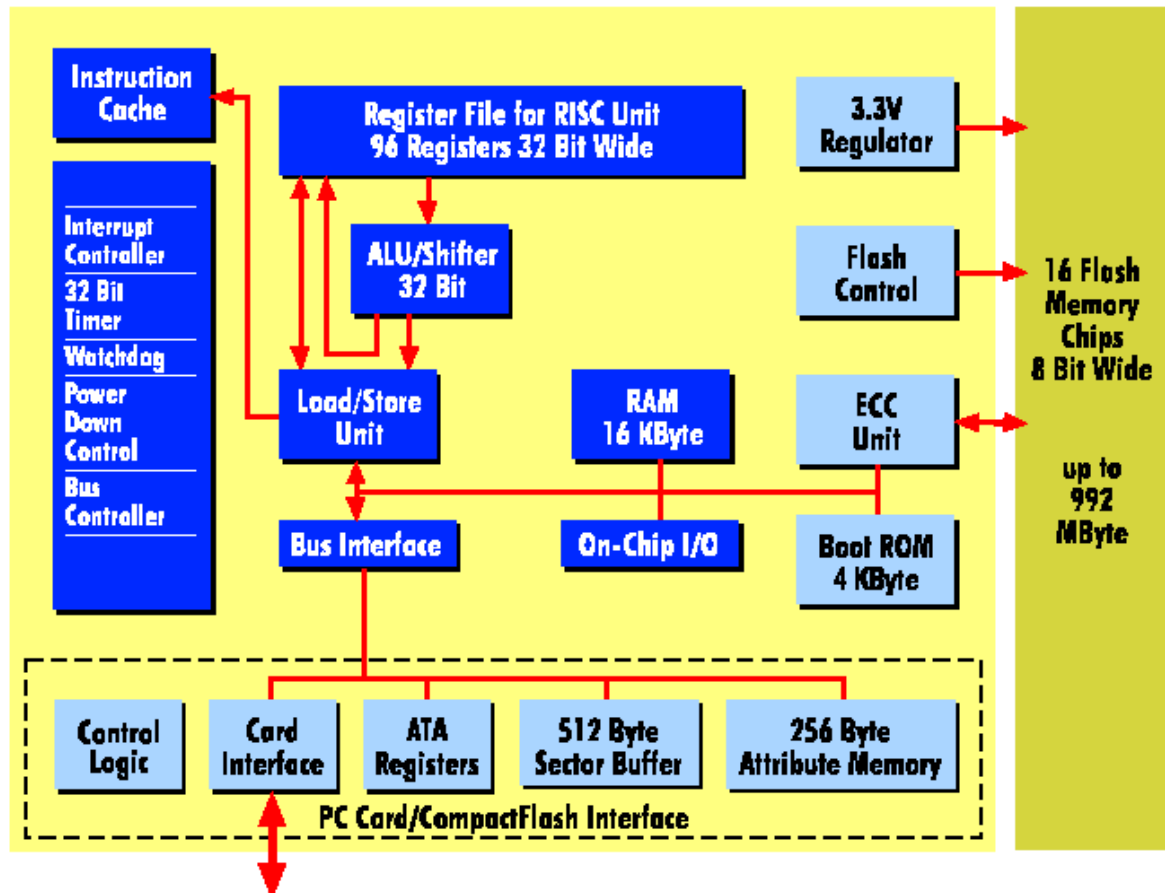
States	Names	Use
O	WE2#, WE3#	SRAM Write Byte Enable. Active low indicates write enable for the byte on D0..D7 (WE3#), or D8..D15 (WE2#), active high indicates write disable. These signals are not available on the F2-16XT.
O	OE#	Output Enable for SRAMs or ROMs. OE# is active low on a SRAM or ROM read access. This signal is not available on the F2-16XT.
O	IORD#	I/O Read Strobe. IORD# is low on I/O read access cycles, high on all other cycles. This signal is not available on the F2-16XT.
O	IOWR#	I/O Write Strobe. IOWR# is active low on I/O write access cycles. This signal is not available on the F2-16XT.
I,D	INT4	<p>Interrupt Request and Boot select. A signal of a specified level on the INT4 interrupt request pins causes an interrupt exception when the interrupt lock flag L is zero and the corresponding INT4Mask bit in FCR is not set. The INT4Polarity bit in FCR specifies the level of the INT4 signal: INT4Polarity = 1 causes an interrupt on a high input signal level, INT4Polarity = 0 causes an interrupt on a low input signal level. INT4 may be signaled asynchronously to the clock; they are not stored internally.</p> <p>The INT4 pin is normally reserved for the hyICE debug connection.</p> <p>Additionally, the INT4 state on a reset exception determines the location of the reset boot procedure. If INT4 is low on reset, the F2-16X begins booting from the internal ROM, if INT4 is high on reset, the F2-16X begins booting from the external MEM3 ROM. This signal is not available on the F2-16XT.</p>
I	RESET#	<p>Reset processor. RESET# low resets the processor to the initial state and halts all activity. RESET# must be low for at least one cycle. On a transition from low to high, a Reset exception occurs and the processor starts execution at the Reset entry determined by the INT4 state. The transition may occur asynchronously to the clock.</p> <p>We recommend connecting this pin to a voltage monitoring circuit with open-drain output (e.g. Torex XC61A) supplying a reset signal for supply voltages less than 2.6 or 2.7V, connected to a R/C combination of 100 kΩ and 100 nF giving an additional reset delay in the order of 10 ms. If no voltage monitoring chip is used, the R/C reset delay should be in the range of about 200 ms, for example with 1 MΩ and 220 nF.</p>
O	FOUT	3.3V Flash Memory Power Supply. This output provides a regulated 3.3V supply if the F2-16X power supply voltage is above 3.3V. This supply voltage must also be connected to the VCC_F pins.

3.4.2. Bus Signal Description (continued)

States	Names	Use
I	FADJ	3.3V Flash Memory Power Supply Adjustment. Connect a * k Ω resistor from this pin to GND, and a * k Ω resistor from this pin to FOUT.
O	COUT	2.5V Core Power Supply. This output provides a regulated 2.5V supply if the F2-16X power supply voltage is above 3.3V. This supply voltage must be connected to the VCC_C pins.
I	CADJ	2.5V Core Power Supply Adjustment. Connect a * k Ω resistor from this pin to GND, and a * k Ω resistor from this pin to COUT.
I,U	PCE1#	PCMCIA Card Enable 1
I,U	PCE2#	PCMCIA Card Enable 2
I	PREG#	PCMCIA Attribute Memory or I/O Enable
I,U	PWE#	PCMCIA Memory Write Enable, Service Mode select (see Boot ROM description)
I,U	POE#	PCMCIA Output Enable, True-IDE Mode select
I,U	PIOWR#	PCMCIA I/O Write Enable
I,U	PIORD#	PCMCIA I/O Read Enable
I,U	PCSEL#	True-IDE Master/Slave select
I	PRESET	PCMCIA Reset signal. This pin includes an input filter that filters pulses shorter than about 40 ns.
I	PA(10..0)	PCMCIA Address Bus
I/O	PD(15..0)	PCMCIA Data Bus
O	PIOIS16#	PCMCIA Write Protect / I/O is 16 bit signal
O	PINPACK#	PCMCIA Input Acknowledge
O,U	PIREQ#	PCMCIA Ready/Busy signal / Interrupt Request
O,U	PSTSCHG#	PCMCIA Status Change / True-IDE DIAG
O,U	PSPKR#	PCMCIA Speaker / True-IDE DASP
O	FWE#	Samsung and Hitachi Flash Memory Write Enable. Connect to the Samsung or Hitachi WE# pin.
O	FOE#/FSC	Samsung Output Enable, Hitachi Bus Clock signal. Connect to Samsung RE# or Hitachi SC pin.
I,U	FRDY	Samsung and Hitachi Flash Ready/Busy signal.
O,D	FRES#	Samsung and Hitachi Flash Write Protect/Reset signal. Connect to the Samsung WP# or Hitachi RES# pin.
O,U	FHOE#	Flash memory type select and Hitachi output enable signal. Connect to ground for Samsung flashes, connect to the Hitachi OE# signal for Hitachi flashes.

4. Functional Description

4.1. Block Diagram



4.2. System Memory Map

The processor provides on-chip all functions for controlling memory and peripheral devices. The number of bus cycles used for a memory or I/O access is also defined by the processor, thus, no external bus controllers are required. All memory and peripheral devices can be connected directly, pin by pin, without any glue logic.

The memory address space is divided into six partitions as follows:

Address (Hex)	Address Space	Memory Type
4000 0000..7FFF FFFF	MEM1	external SRAM
8000 0000..BFFF FFFF	MEM2	external Flash Memory
C000 0000..C7FF FFFF	IRAM	Internal RAM
C800 0000..CFFF FFFF	IRAM	Sector Buffers, Attribute Memory
D000 0000..DFFF FFFF	IROM	Internal Boot ROM
E000 0000..FFFF FFFF	MEM3	external ROM

Access to the registers of the PCMCIA and flash memory interface takes place in the processor's I/O address space.

4.3. Flash Memory Interface

Samsung type or Hitachi type flash memory chips are connected to the *Hyperstone* F2-16X as described below.

4.3.1. Samsung KM29N32000TS (or similar)

Samsung KM29N32000TS	F2-16X
CLE	A2
ALE	A3
CE#	one of A19..A4
WE#	FWE#
RE#	FOE#/FSC
SE#	GND
I/O 0 ... I/O 7 (I/O 15)	D0 ... D7 (D15)
WP#	FRES#
Ready/Busy#	FRDY

The FHOE# pin is grounded externally to indicate that Samsung flash memory is connected. In order to avoid static current flowing through the FHOE# pull-up resistor, the FHOE# pin should be switched to output driving 0 when the low state of FHOE# is detected.

When a Samsung flash memory chip is connected, the FCR bit 7 must remain set in the default reset state (1). Switching this bit to 0 with a Samsung flash memory chip connected may cause a collision on the *Hyperstone* F2-16X data bus.

The FWE# and FOE# control signals are activated on any MEM2 write or read access when address bit A22 is set to zero. Address lines A19 to A2 are used for control signal and chip select generation. Address bits A1 to A0 should not be connected and should be zero on a MEM2 access so that word accesses are possible.

Setting A22 to one on a MEM2 write or read access inhibits the generation of the FWE# and FOE# signals. This mode may be used to pre-set the address or data lines to a specific value without causing an actual access.

At most 16 Samsung flash chips can be connected to the *Hyperstone* F2-16X. Since address bit A2 is used as CLE, double-word flash accesses are not possible. Flash chip 0 CE# is A4, chip 1 CE# is A5, ... chip 15 CE# is A19.

4.3.2. Hitachi HN29W6411 (or similar)

Hitachi HN29W6411	F2-16X
CDE#	A3
CE#	one of A19..A4
WE#	FWE#
SC	FOE#/FSC
OE#	FHOE#
I/O 0 ... I/O 7	D0 ... D7
RES#	FRES#
RDY/Busy#	FRDY

The FHOE# pin is connected to the OE# pin of the Hitachi flash memory chip. The FHOE# pin sets the OE# signal to high via a pull-up resistor. This logic level can be used to indicate that a Hitachi flash memory chip is connected. The FHOE# pin should be switched to output driving 1 when the high state of FHOE# is detected.

Bit 7 in FCR should be set to 0 enabling the Hitachi control signals on FWE# and FOE#/FSC pins when a high state at FHOE# is detected. This should be done before the FRES# pin is brought high.

The FWE# control signal is activated on a MEM2 write access when $A21 = 0$ and $A22 = 0$. In order to meet the timing requirements, these accesses must be performed with a minimum of 2 access cycles at 16 MHz or 3 access cycles at 18 MHz. The OE# signal must be high during these accesses.

The FSC control signal is activated on a MEM2 read or write access when $A21 = 1$ and $A22 = 0$. For these accesses, a single-cycle access time is allowed up to a clock frequency of 18 MHz. Before a write access, the FHOE# signal must be brought high, for a read access, the FHOE# signal must be brought low before the accesses and back high after the accesses.

Setting A22 to one on a MEM2 write or read access inhibits the generation of the FWE# and FSC signals. This mode may be used to pre-set the address or data lines to a specific value without causing an actual access.

At most 16 Hitachi flash chips can be connected to the *Hyperstone* F2-16X. Flash chip 0 CE# is A4, chip 1 CE# is A5, ... chip 15 CE# is A19.

4.4. ECC Unit

The ECC unit consists of the Parity Unit (parity byte generation) and the Syndrome Unit (syndrome byte computation). This unit implements a Reed-Solomon ECC that is able to correct two bytes in an ECC block. The maximum ECC block length is 251 bytes.

The parity unit listens to MEM2 write accesses when $A20 = 1$ and processes the byte present on the output data lines. The syndrome unit listens to MEM2 read accesses when $A20 = 1$ and processes the byte present on the read data lines. The parity and syndrome units process one byte per clock cycle. When the MEM2 bus width is 16 bit, the MEM2

access time must be at least 2 clock cycles to give the time to process both bytes of a MEM2 access. In this case, data bits 15..8 are processed first, then data bits 7..0.

The generated parity bytes b3..b0 and the generated syndrome bytes s3..s0 can be read from the ECC unit using the I/O interface. The ECC unit responds to internal I/O accesses ($A_{27} = 1$) when $A_{22} = 1$.

There is an 8 bit down counter register associated with the syndrome unit. Whenever bytes are sent to the syndrome unit (on a MEM2 read with $A_{20} = 1$) the counter is decremented by one for each byte that is equal to FF_{16} . This counter register can be used to check the number of non-erased (value not equal to FF_{16}) bytes in a data block.

A16	A15	A14	A13	R/W	Description
0	0	0	0	R	read 16 bit parity bytes b2, b3
0	0	0	1	R	read 16 bit parity bytes b0, b1
0	0	1	0	R	read 16 bit syndrome bytes s3, s2
0	0	1	1	R	read 16 bit syndrome bytes s1, s0
0	0	0	x	W	reset parity bytes b3 ... b0 to zero
0	0	1	0	W	write 16 bit syndrome bytes s3, s2
0	0	1	1	W	write 16 bit syndrome bytes s1, s0
0	1	0	0	W	write 8 bit down counter register
0	1	0	0	R	read 8 bit down counter register
0	1	0	1	W	write 8 bit data into parity unit (for test)
0	1	1	1	W	write 8 bit data into syndrome unit (for test)

4.5. SmartMedia Unit

The SmartMedia Unit computes the Line Parity and Column Parity information of the SmartMedia ECC for a data block of up to 256 bytes according to the SmartMedia Physical Format Specification.

The SmartMedia unit listens to MEM2 read or write accesses when $A_{24} = 1$ and processes the byte present on the read or write data lines. The SmartMedia unit processes one or two bytes per clock cycle, depending on the MEM2 bus width.

The generated line and column parity bytes can be read from the SmartMedia unit using the I/O interface. The SmartMedia unit responds to internal I/O accesses ($A_{27} = 1$) when $A_{22} = 1$.

A16	A15	A14	A13	R/W	Description
1	0	0	0	R	read even Line Parity and Column Parity
1	0	0	1	R	read odd Line Parity and Column Parity
1	0	0	x	W	reset Line Parity and Column Parity to 1, reset byte counter
1	1	0	0	R/W	read/write Line Parity LP(7..0)
1	1	0	1	R/W	read/write Line Parity LP(15..8)
1	1	1	0	R/W	read/write Column Parity CP(5..0)

The bit arrangements are the following:

A16	A15	A14	A13	R/W	Data Bits															
					15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
													Line Parity				Column P			
1	0	0	0	R	zero					14	12	10	8	6	4	2	0	4	2	0
1	0	0	1	R	zero					15	13	11	9	7	5	3	1	5	3	1
1	0	0	x	W	don't care															
													Line Parity							
1	1	0	0	R/W	zero								7	6	5	4	3	2	1	0
1	1	0	1	R/W	zero								15	14	13	12	11	10	9	8
													Column Parity							
1	1	1	0	R/W	zero								5	4	3	2	1	0	one	

4.6. Reset and ROM boot

The **Hyperstone** F2-16XN uses the INT4 line state at reset to select between booting from internal boot ROM and booting from external MEM3. The INT4 pad has an internal pull-down resistor so that INT4 is low when INT4 is not connected.

If the INT4 line is high at reset (connected to the interrupt line of the **hyICE**), the **Hyperstone** F2-16XN reset begins fetching instructions from MEM3 address FFFF FFF8₁₆. If the INT4 line is low at reset (no **hyICE** connected), the F2-16XN begins booting from its internal boot ROM. The F2-16XT does not have the INT4 pin so it always boots from the internal boot ROM.

If the **Hyperstone** F2-16XN should boot from the internal boot ROM with the **hyICE** connected (for example to have the two LEDs available), the **hyICE**'s interrupt line must be disconnected from the INT4 pin by pulling the corresponding jumper on the **hyICE**.

4.7. PCMCIA Interface

The register model of the **Hyperstone** F2-16X PCMCIA consists of three groups of registers: the F2-16X only registers, the PCMCIA configuration registers and the ATA register file. The F2-16X PCMCIA interface responds to internal I/O accesses ($A27 = 1$) when $A25 = 0$.

The F2-16X address mapping together with the read/write status of the registers when accessed by the **Hyperstone** F2-16X or the PCMCIA host in the Busy or Not Busy state is given in the following table:

A24	A23	A16	A15	A14	A13	Reg	Busy hy PC		Not Busy hy PC		Description
1	0			0	0	ISR	R/W	-	R/W	-	Interrupt Status Register
1	0			0	1	MSR	R/W	-	R/W	-	Mode and Control Register
1	0			1	0	TIR	R/W	-	R/W	-	True-IDE Mode Register
1	0			1	1	PIR	W	-	W	-	PCMCIA Interrupt Register
0	1	1	0	1	0	C1	R/W	R	R	R/W	Configuration Option Register
0	1	1	0	1	1	C2	R/W	R	R	R/W	Card Config. and Status Reg.
0	1	1	1	0	0	C3	R/W	R	R	R/W	Pin Replacement Register
0	1	1	1	0	1	C4	R/W	R	R	R/W	Socket and Copy Register
0	1	0	0	0	0	-					-
0	1	0	0	0	1	A01	R/W	-	-	W	ATA Feature Register
0	1	0	0	1	0	A02	R/W	-	-	R/W	ATA Sector Count Register
0	1	0	0	1	1	A03	R/W	-	-	R/W	ATA Sector Number Register
0	1	0	1	0	0	A04	R/W	-	-	R/W	ATA Cylinder Low Register
0	1	0	1	0	1	A05	R/W	-	-	R/W	ATA Cylinder High Register
0	1	0	1	1	0	A06	R/W	-	-	R/W	ATA Drive/Head Register
0	1	0	1	1	1	A07	R/W	-	-	W	ATA Command Register
0	1	1	0	0	0	A00	R/W	R	R/W	R	ATA Status Register
0	1	1	0	0	1	A08	W	-	-	R	ATA Error Register
0	1	1	1	1	0	A10	R/W+	W	W+	W	ATA Device Control Register
0	1	1	1	1	1	A09	R/W	-	-	R	ATA Drive Address Register

W+ means that the register is writable, but coinciding accesses from the other side (PC) will be corrupted.

4.7.1. Register Descriptions for the F2-16X Registers

4.7.1.1 F2-16X Register Access

The F2-16X PCMCIA control registers ISR, MSR, TIR and PIR are exclusively owned by the F2-16X and may be read and written at any time. An internal I/O access is used to read and write the F2-16X PCMCIA control registers.

4.7.1.2 Mode and Control Register

MSR bit	Description
0	<p>ATA Mode bit</p> <p>0 = PCMCIA ATA mode (reset default if POE# is high) 1 = True IDE mode (reset default if POE# is low)</p> <p>This bit should not be changed by software. When the True-IDE detection enable bit is set in PIR, this bit falls back to 0 if POE# was low at reset time as soon as POE# changes back to high. When the True-IDE detection enable bit in PIR is cleared, this bit is not affected by changes of the POE# pin.</p>

MSR bit	Description
1	Access Mode bit 0 0 = Memory Mapped access (reset default) 1 = I/O Mapped access
2	Access Mode bit 1 0 = Contiguous I/O address decoding (when I/O mapped access is selected) 1 = Primary/Secondary I/O address decoding (when I/O mapped access is selected) For memory mapped access, this bit must be set to 0. The reset default for this bit is 0.
3	PCMCIA Interrupt Status (PIREQ#), read-only 0 = PCMCIA Interrupt line not active (reset default) 1 = PCMCIA Interrupt line active The PCMCIA Interrupt line is controlled in PIR.
4	Clear Sector Buffer Address Counter, write only, normally reads as 0 0 = Normal Address Counter Operation (reset default) 1 = Clear Address Counter Writing a 1 to this bit also clears the Address Counter Overflow bit in ISR. This bit also captures the "Service Mode" state at power-on reset. When both PWE# and PWAIT# are low at power-on, this bit reads as 1 as long as both PWE# and PWAIT# are low. When at least one of PWE# or PWAIT# goes back high, this bit reverts to the 0 state and stays there. This feature is used in the internal boot ROM to switch to a "Service Mode" where F2-16X boots via the PCMCIA interface. Before the PCMCIA boot is completed, the PWE# or PWAIT# pin should be brought back high so that this bit reads as 0 during normal operation.
5	PCMCIA Reset (PRESET) Status, read only 0 = PCMCIA reset is not active 1 = PCMCIA reset is active PCMCIA reset polarity is high active in PCMCIA mode, low active in True-IDE mode
6	DMA Request in True-IDE mode 0 = DMA Request inactive (low on PINPACK#, reset default) 1 = DMA Request active (high on PINPACK#) The DMA Request bit is automatically reset to the inactive state during a DMA transfer at the beginning of the PIORD# or PIOWR# pulse when the last byte of a sector is read or written.
7	Busy Set Enable on Address Counter Overflow 0 = Busy flag is not affected by an Address Counter overflow (reset default) 1 = Busy flag is set whenever the Address Counter overflows
8	Sector Buffer Access Select 0 = F2-16X accesses Sector Buffer 0, PC accesses Sector Buffer 1 (reset default) 1 = F2-16X accesses Sector Buffer 1, PC accesses Sector Buffer 0
9	DMA Request Driver Enable in True-IDE mode 0 = Driver disabled, PINPACK# pad is tristate (reset default) 1 = Driver enabled, PINPACK# pad is enabled when the drive is selected In PCMCIA I/O mode (non-True-IDE), the PINPACK# driver is always enabled, and the pad performs the "Input Acknowledge" functionality.
10	State at the PINPACK# pad (True-IDE DMARQ), read only 0 = PINPACK# pad is low (DMARQ inactive) 1 = PINPACK# pad is high (DMARQ active)

MSR bit	Description
11	State at the PREG# pad (True-IDE DMACK#), read only 0 = PREG# is high (DMACK inactive) 1 = PREG# is low (DMACK active)
12..14	Reserved
15	PCMCIA CIS Write Permission 0 = CIS (in Attribute Memory) is not writable from the host (reset default) 1 = CIS (in Attribute Memory) is writable from the host

At boot time, the *Hyperstone* F2-16X software must read out the ATA Mode bit and initialize the two access mode bits to memory-mapped mode for PCMCIA ATA mode and to Primary I/O mode in True IDE mode. The configuration index in the PCMCIA Configuration Option Register must be initialized to zero for PCMCIA ATA mode and to nonzero for True IDE mode.

4.7.1.3 True-IDE Mode Register

TIR bit	Description
0	PDIAG (signal is on PSTSCHG#) 0 = PSTSCHG# pad is tristate (reset default) 1 = pull PSTSCHG# pad low When read, this bit reflects the PSTSCHG# pad's state (low reads as 1).
1	PDASP (signal is on PSPKR#) 0 = PSPKR# pad is tristate (reset default) 1 = pull PSPKR# pad low When read, this bit reflects the PSPKR# pad's state (low reads as 1).
2	Drive Select 0 = Drive selects as Master (reset default if PCSEL# is low) 1 = Drive selects as Slave (reset default if PCSEL# is high) This bit must be initialized to 0 for the PCMCIA mode.
3	Drive 1 Status Register Read Enable 0 = Disable reading drive 1 status register (reset default) 1 = Enable reading drive 1 status register This bit must be set in True IDE mode when our drive is configured as master with no slave present.
4	8 Bit Data Register Access Enable 0 = True-IDE data register access is 16 bit per transfer (reset default) 1 = True-IDE data register access is 8 bit per transfer
5	Multiple Controllers Master/Slave Select 0 = Single controller, or master with multiple controllers (reset default) 1 = Slave with multiple controllers
6	BUSRQ Line Control 0 = BUSRQ line is tristate, with pull-up on master (reset default) 1 = BUSRQ line is driven low When read, this bit reflects the BUSRQ pad's state (low reads as 1).

When multiple controllers are connected to the PCMCIA bus, exactly one of these must be the master, all others must be slave. The PCMCIA lines of a controller are driven if either

- a controller is master, and the BUSRQ line is high, or
- a controller is slave, and pulls the BUSRQ line low.

4.7.1.4 Interrupt Status Register

When any of the ISR bits is set, the processor's INT1 or INT2 interrupts are activated. The interrupt service routine should read ISR, clear the bits it found set, and act upon them. A bit in ISR is cleared by writing a 1 bit into the appropriate bit position, writing a 0 bit to a bit position does not affect the bit's value.

ISR bit	Description
0	Configuration Register Write Interrupt 1 = The PCMCIA Configuration Option Register was written by the PCMCIA host.
1	Command Register Write Interrupt 1 = The ATA Command Register was written by the PCMCIA host. The Command Register Write causes the Busy flag to be set.
2	Address Counter Overflow Interrupt 1 = The Sector Buffer Address Counter passed the end of the sector buffer. This bit is also cleared by writing a 1 into MSR bit 4. The Address Counter overflow causes the Busy flag to be set if this is enabled in MSR bit 7.
3	PCMCIA Soft Reset was set Interrupt 1 = The Soft Reset bit was set in the ATA Device Control Register or in the PCMCIA Configuration Option Register. The Soft Reset via the ATA Device Control Register causes the Busy flag to be set.
4	PCMCIA Soft Reset was cleared Interrupt 1 = The Soft Reset bit was cleared in the ATA Device Control Register or in the PCMCIA Configuration Option Register.
5	PCMCIA Power Down Request Interrupt 1 = The Power Down Request bit was set in the PCMCIA Card Configuration and Status Register
6	PCMCIA Reset (PRESET) was set Interrupt 1 = The PCMCIA Reset line was activated.
7	PCMCIA Reset (PRESET) was cleared Interrupt 1 = The PCMCIA Reset line was deactivated.
8..12	Flash Ready Interrupts 0..4 1 = Rising edge detected on address line A9..A13.

Any bit set in positions 0..7 of ISR activates interrupt INT1. Any bit set in positions 8..12 of ISR activates interrupt INT2.

4.7.1.5 PCMCIA Interrupt Register

PIR bit	Description
0	Set PCMCIA Interrupt Request to the PCMCIA host (write only) 0 = No operation 1 = The PCMCIA Interrupt line is set. Both the PCMCIA Interrupt line and the Interrupt bit in the PCMCIA Card Configuration and Status Register are reset when: - the ATA Status Register is read by the PCMCIA host - the ATA Command Register is written by the PCMCIA host - the PCMCIA Soft Reset was set Interrupt bit in ISR is set - and on a power-on reset.
1	Clear PCMCIA Interrupt Request to the PCMCIA host (write only) 0 = No operation 1 = The PCMCIA Interrupt line is reset.
2	Set Interrupt bit in the PCMCIA Card Configuration and Status Register (write only) 0 = No operation 1 = The Interrupt bit in the PCMCIA Card Configuration and Status Register is set.
3	Clear Interrupt bit in the PCMCIA Card Configuration and Status Register (write only) 0 = No operation 1 = The Interrupt bit in the PCMCIA Card Configuration and Status Register is cleared.
4..5	Unused
6	Set True-IDE Detection Enable 0 = No operation 1 = The True-IDE detection enable bit is set. The True-IDE detection enable bit is set after power-on reset. As long as this bit is set, the True-IDE bit in MSR is reset to 0 as soon as a high (inactive) level is recognized on the POE# pin. When this bit is not reset, POE# activity does not affect the MSR True-IDE bit.
7	Clear True-IDE Detection Enable 0 = No operation 1 = The True-IDE detection enable bit is cleared.

4.7.2. Register Descriptions for the PCMCIA Registers

4.7.2.1 PCMCIA Configuration Register Access

The PCMCIA Configuration Registers can be accessed via internal I/O accesses by the F2-16X and via PCMCIA memory accesses by the PCMCIA host. Write access to these registers is guarded by the Busy flag: when Busy is set, the F2-16X may write the PCMCIA Configuration Registers, when Busy is clear, the PCMCIA host may write these registers.

For the PCMCIA host access to the PCMCIA configuration registers, an Attribute Memory read or write access is needed with an address of 200₁₆, 202₁₆, 204₁₆ or 206₁₆. These addresses select C1, C2, C3 and C4, respectively.

4.7.2.2 Configuration Option Register

C1 bit	Description
5..0	Configuration Index
6	PCMCIA Interrupt Mode Select 0 = Pulse Mode Interrupts 1 = Level Mode Interrupts
7	PCMCIA Soft Reset 0 = Normal operation 1 = Software Reset

Any write access by the PCMCIA host to this register causes a Configuration Register Write Interrupt.

The F2-16X disables I/O accesses from the PCMCIA interface as long as the Configuration Index is zero. Prior to enabling the I/O interface in MSR, a Configuration Index unequal to zero must be written. This is done by the host (in PCMCIA mode) or must be done by the F2-16X (in True-IDE mode).

When the PCMCIA Soft Reset bit is changed, a PCMCIA Soft Reset interrupt is generated.

4.7.2.3 Card Configuration and Status Register

C2 bit	Description
0	Reserved (0)
1	PCMCIA Interrupt (read only) This bit is controlled by bits 0 and 2 of PIR.
2	PCMCIA Power Down Request 0 = Normal Operation 1 = Enter Power Down mode.
3	PCMCIA Audio This bit is unused in F2-16X and should be set to 0.
4	Reserved (0)
5	PCMCIA IOis8 This bit should be set to 0 by the F2-16X since 16 bit I/O is possible.
6	Signal State Change 0 = State Changes (the Changed bit) should not be reported through PSTSCHG# 1 = State Changes are reported through the PSTSCHG# signal.
7	Changed (read only) This bit represents the logical or of bits 4 to 7 of the Pin Replacement Register.

When the PCMCIA Power Down Request bit is set, a PCMCIA Power Down Request interrupt is generated.

4.7.2.4 Pin Replacement Register

All PCMCIA Pin Replacement Register bits can be written by the F2-16X. In order to conform to the PCMCIA protocol, every time a bit from bits 0 to 3 is set, the corresponding bit in bits 4 to 7 must be set by the F2-16X. This can be done by a read-modify-write cycle

since write accesses to the Pin Replacement Register are guarded by the Busy signal. When a bit from bits 0 to 3 is reset, the corresponding bit in bits 4..7 must not be changed.

The PCMCIA host has no write access to bits 0 to 3. Bits 4 to 7 can be written by the PCMCIA host through a write mask in the corresponding bit of bits 0 to 3: for example, if the PCMCIA host performs a write access to the Pin Replacement Register with data bits 1 and 2 set, bits 5 and 6 of the Pin Replacement Register are written with the data bits 5 and 6 from the PCMCIA host, and bits 0 to 3, 4 and 7 are not changed by this write access.

C3 bit	Description
0	Write Protect This bit is used to generate the WP signal (PIOIS16# pin) in memory-mapped mode.
1	Ready/-Busy
2	Battery Voltage Detect 2 (set to 0 when no battery is there)
3	Battery Voltage Detect 1 (set to 0 when no battery is there)
4	Changed Write Protect
5	Changed Ready/-Busy
6	Changed Battery Voltage Detect 2
7	Changed Battery Voltage Detect 1

4.7.2.5 Socket and Copy Register

C4 bit	Description
3..0	Socket Number
6..4	Copy Number
7	Reserved (0)

4.7.3. Register Descriptions for the ATA Task File Registers

4.7.3.1 ATA Task File Register Access

The ATA Task File Registers can be accessed by the F2-16X using internal I/O accesses and by the PCMCIA host using I/O or memory accesses on the PCMCIA interface. See section 4.8 [Register and Sector Buffer Access Modes](#) for details.

4.7.3.2 ATA Feature Register

A01 bit	Description
7..0	Command Specific

4.7.3.3 ATA Sector Count Register

A02 bit	Description
7..0	Sector Count for read or write operation. Sector Count 0 means 256 sectors.

4.7.3.4 ATA Sector Number Register

A03 bit	Description
7..0	Sector Number for the next command, range 1 to max. number of sectors per track. LBA bits 7..0 in LBA addressing mode.

4.7.3.5 ATA Cylinder Low Register

A04 bit	Description
7..0	Bits 7..0 of the starting cylinder number for the next command. LBA bits 15..8 in LBA addressing mode.

4.7.3.6 ATA Cylinder High Register

A05 bit	Description
7..0	Bits 15..8 of the starting cylinder number for the next command. LBA bits 23..16 in LBA addressing mode.

4.7.3.7 ATA Drive/Head Register

A06 bit	Description
3..0	Head number to select for the next command (0..15). LBA bits 27..24 in LBA mode.
4	Drive 0 select (0) or Drive 1 select (1)
5	Reserved (1)
6	Addressing Mode select 0 = addressing is by Cylinder/Head/Sector (CHS mode) 1 = addressing is by LBA mode
7	Reserved (1)

4.7.3.8 ATA Command Register

A PCMCIA write access to the ATA Command Register causes the Busy flag to be set and generates a Command Register Write Interrupt.

A07 bit	Description
7..0	Command Code for the next command to be executed.

4.7.3.9 ATA Status Register, ATA Alternate Status Register

The ATA Status Register and the ATA Alternate Status Register carry the same information. The only difference is, reading the ATA Status Register implies an interrupt acknowledge and resets the PCMCIA Interrupt line while reading the ATA Alternate Status Register does not.

A00 bit	Description
0	ERR (Error). An error occurred during command execution, further information can be found in the Error Register
1	IDX (Index).
2	CORR (Corrected Data). A correctable data error occurred and the data has been corrected.
3	DRQ (Data Request). The drive is ready to transfer data. This bit is cleared when a host Data Register access causes an Address Counter overflow.
4	DSC (Drive Seek Complete).
5	DWF (Drive Write Fault)
6	DRDY (Drive Ready). The drive is ready to accept a command.
7	BSY (Busy). This bit indicates that the drive has access to the ATA Registers. When any ATA register is read by the PCMCIA host, the Status Register content is returned.

The F2-16X hardware sets the Busy flag on any of the following events:

- ☐ power-up reset
- ☐ any PCMCIA write access to the ATA Command Register
- ☐ the Soft Reset bit in the ATA Device Control Register is being set
- ☐ sector buffer address counter overflow when MSR bit 7 is set.

4.7.3.10 ATA Error Register

A08 bit	Description
7..0	Status from the last command, valid when the ERR bit in the ATA Status Register is set. Diagnostic code from Execute Drive Diagnostics command.

4.7.3.11 ATA Device Control Register

A10 bit	Description
0	Reserved (0)
1	nIEN (negated Interrupt Enable). This bit is initialized to 0 on power-on reset and on PCMCIA reset assertion. 0 = Interrupt is enabled 1 = Interrupt is disabled
2	SRST (Soft Reset). This bit is initialized to 0 on reset.
3	Reserved (1)

The PCMCIA Interrupt line is used as Ready/-Busy output in memory-mapped mode. In I/O mode, the interrupt line state is determined by the PCMCIA Interrupt bit that is set or reset by PIR bits 0 and 1 and queried in MSR bit 5. In PCMCIA I/O mode, the interrupt line is always driven (active high) according to the PCMCIA Interrupt bit. In True-IDE mode, the interrupt line is driven (active low) according to the PCMCIA Interrupt bit when the drive is selected (bit 4 in the ATA Drive/Head Register equals bit 2 in TIR), else the interrupt line is tristate.

When the SRST bit is being set by the PCMCIA host, the Busy flag is set and a PCMCIA Soft Reset was set Interrupt is generated. When this bit is being cleared by the PCMCIA host, a PCMCIA Soft Reset was cleared Interrupt is generated.

4.7.3.12 ATA Drive Address Register

A09 bit	Description
0	nDS0 (negated Drive Select 0). Low when drive 0 is selected and active.
1	nDS1 (negated Drive Select 1). Low when drive 1 is selected and active.
5..2	nHS3..nHS0 (negated head select). Contains the negated binary address of the currently selected head.
6	nWGT (negated Write Gate). Low when a write to the disk is in progress.
7	HiZ

The ATA Drive Address Register is only available in PCMCIA memory or I/O modes. In True-IDE mode, the F2-16X controller does not respond to ATA Drive Address Register accesses.

4.8. Register and Sector Buffer Access Modes

The Sector Buffer (512 byte) and ATA Task File Registers are available in both memory-mapped and I/O access mode in the PCMCIA Common Memory area.

4.8.1. Access Modes in PCMCIA memory-mapped mode

For common memory access (Sector Buffer and ATA Task File), the access signals are:

PREG#	PCE2#	PCE1#	PA0	Access	Description
x	1	1	x	-	Standby
1	1	0	0	WE/OE	Byte access (even byte), data on PD(7..0)
1	1	0	1	WE/OE	Byte access (odd byte), data on PD(7..0)
1	0	1	x	WE/OE	Byte access (odd byte), data on PD(15..8)
1	0	0	x	WE/OE	Word access, data on PD(15..0)

Word accesses are permitted for Sector Buffer (Data Register) accesses as well as for ATA Task File Register accesses. On word accesses to the ATA Task File Registers, the even and odd addresses are accessed simultaneously.

The Sector Buffer (Data Register) and ATA Task File Register addresses in memory-mapped mode are given in the following table.

PA10	PA9..4	PA3	PA2	PA1	PA0	Read (OE)	Write (WE)
0	x	0	0	0	even	Data Register, byte access	Data Register, byte acc.
0	x	0	0	0	word	Data Register, word acc.	Data Register, word acc.
0	x	0	0	0	odd	Error Register	Feature Register
0	x	0	0	1	even	Sector Count	Sector Count
0	x	0	0	1	odd	Sector Number	Sector Number
0	x	0	1	0	even	Cylinder Low Register	Cylinder Low Register
0	x	0	1	0	odd	Cylinder High Register	Cylinder High Register
0	x	0	1	1	even	Drive/Head Register	Drive/Head Register
0	x	0	1	1	odd	Status Register	Command Register
0	x	1	0	0	even	Duplicate Data, even byte	Duplicate Data, even byte

PA10	PA9..4	PA3	PA2	PA1	PA0	Read (OE)	Write (WE)
0	x	1	0	0	odd	Duplicate Data, odd byte	Duplicate Data, odd byte
0	x	1	0	0	word	Duplicate Data	Duplicate Data
0	x	1	1	0	odd	Duplicate Error Register	Duplicate Error Register
0	x	1	1	1	even	Alternate Status Register	Device Control Register
0	x	1	1	1	odd	Drive Address Register	-
1	x	x	x	x	even	Data Register, even byte	Data Register, even byte
1	x	x	x	x	odd	Data Register, odd byte	Data Register, odd byte
1	x	x	x	x	word	Data Register	Data Register

For Attribute Memory (CIS and PCMCIA Configuration Registers), only even addresses are valid. The access signals are:

PREG#	PCE2#	PCE1#	PA0	Access	Description
x	1	1	x	-	Standby
0	1	0	0	WE/OE	Byte access (even byte), data on PD(7..0)
0	1	0	1	WE/OE	not valid
0	0	1	x	WE/OE	not valid
0	0	0	x	WE/OE	Word access, even byte data on PD(7..0)

The Attribute Memory (Card Information Structure) and PCMCIA Configuration Register addresses in memory-mapped mode are given in the following table.

PA9	PA8..3	PA2	PA1	PA0	Description
0	8 bit address			even	256 bytes Card Information Structure
1	x	0	0	even	PCMCIA Configuration Option Register (C1)
1	x	0	1	even	PCMCIA Card Configuration and Status Register (C2)
1	x	1	0	even	PCMCIA Pin Replacement Register (C3)
1	x	1	1	even	PCMCIA Socket and Copy Register (C4)

Write accesses to the Card Information Structure are only possible if the PCMCIA CIS Write Permission bit in MSR is set.

4.8.2. Access Modes in PCMCIA I/O mode

In I/O mode, common and attribute memory access signals are:

PREG#	PCE2#	PCE1#	PA0	Access	Description
x	1	1	x	-	Standby
0	1	0	0	IOWR/RD	Byte access (even byte), data on PD(7..0)
0	1	0	1	IOWR/RD	Byte access (odd byte), data on PD(7..0)
0	0	1	x	IOWR/RD	Byte access (odd byte), data on PD(15..8)
0	0	0	x	IOWR/RD	Word access, data on PD(15..0)

PREG#	PCE2#	PCE1#	PA0	Access	Description
0	x	x	x	WE/OE	Attribute Memory access, see memory-mapped mode

Word accesses are permitted for Sector Buffer (Data Register) accesses as well as for ATA Task File Register accesses. On word accesses to the ATA Task File Registers, the even and odd addresses are accessed simultaneously.

The Sector Buffer (Data Register) and ATA Task File Register addresses in Contiguous I/O mode are given in the following table.

PA3	PA2	PA1	PA0	Read (IORD)	Write (IOWR)
0	0	0	even	Data Register, byte access	Data Register, byte access
0	0	0	word	Data Register, word access	Data Register, word access
0	0	0	odd	Error Register	Feature Register
0	0	1	even	Sector Count	Sector Count
0	0	1	odd	Sector Number	Sector Number
0	1	0	even	Cylinder Low Register	Cylinder Low Register
0	1	0	odd	Cylinder High Register	Cylinder High Register
0	1	1	even	Drive/Head Register	Drive/Head Register
0	1	1	odd	Status Register	Command Register
1	0	0	even	Duplicate Data, even byte	Duplicate Data, even byte
1	0	0	odd	Duplicate Data, odd byte	Duplicate Data, odd byte
1	0	0	word	Duplicate Data	Duplicate Data
1	1	0	odd	Duplicate Error Register	Duplicate Error Register
1	1	1	even	Alternate Status Register	Device Control Register
1	1	1	odd	Drive Address Register	-

The Sector Buffer (Data Register) and ATA Task File Register addresses in Primary or Secondary I/O mode are given in the following table.

PA9	PA2	PA1	PA0	Read (IORD)	Write (IOWR)
0	0	0	even	Data Register, byte access	Data Register, byte access
0	0	0	word	Data Register, word access	Data Register, word access
0	0	0	odd	Error Register	Feature Register
0	0	1	even	Sector Count	Sector Count
0	0	1	odd	Sector Number	Sector Number
0	1	0	even	Cylinder Low Register	Cylinder Low Register
0	1	0	odd	Cylinder High Register	Cylinder High Register
0	1	1	even	Drive/Head Register	Drive/Head Register
0	1	1	odd	Status Register	Command Register
1	1	1	even	Alternate Status Register	Device Control Register
1	1	1	odd	Drive Address Register	-

4.8.3. Access Modes in True-IDE mode

In True-IDE mode, only common memory (Sector Buffer and ATA Task File) is addressable. The access signals are:

PREG#	PCE2#	PCE1#	Access	Description
x	1	1	-	Standby
x	1	0	IOWR/RD	ATA Command block access (Cmd in table below)
x	0	1	IOWR/RD	ATA Control block access (Ctrl in table below)
x	0	0	IOWR/RD	not valid

A word access is valid only for the Sector Buffer (Data Register) access.

The Sector Buffer (Data Register) and ATA Task File Register addresses in True-IDE Primary or Secondary I/O mode are given in the following table.

Block	PA2	PA1	PA0	Read (IORD)	Write (IOWR)
Cmd	0	0	0	Data Register, word access	Data Register, word access
Cmd	0	0	1	Error Register	Feature Register
Cmd	0	1	0	Sector Count	Sector Count
Cmd	0	1	1	Sector Number	Sector Number
Cmd	1	0	0	Cylinder Low Register	Cylinder Low Register
Cmd	1	0	1	Cylinder High Register	Cylinder High Register
Cmd	1	1	0	Drive/Head Register	Drive/Head Register
Cmd	1	1	1	Status Register	Command Register
Ctrl	1	1	0	Alternate Status Register	Device Control Register

The Drive Address Register is not available in True-IDE mode.

4.9. Hyperstone Sector Buffer Access

The sector buffers and the attribute memory are available on the Hyperstone side in the IRAM access space, starting at C800 0000₁₆. There are two sector buffers of 528 bytes (132 words of 32 bits), and a 256 byte attribute memory. Read accesses to these memories are unrestricted, write accesses must always be in 32 bit units (byte or halfword write accesses are not allowed).

The selection which of the sector buffers are accessed from the Hyperstone side and from the host side depends on the Sector Buffer Select bit in MCR, and on the Busy state. The access modes are detailed in the following table. When Busy is 0, the host side (PCMCIA) always has access to sector buffer SB0 when MSR(8) is 1, and to sector buffer SB1 when MSR(8) is 0.

The 256 byte attribute memory is mapped to 256 words in this address range, with the 8 bit data in bits 31..24 of these words.

Busy	Hyperstone Address Bits																Hy Access MSR(8)=0	Hy Access MSR(8)=1
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
0	0	x	0	x	x	0	528 byte										SB0	SB1
0	X	x	x	x	x	1	x	x	x	x	x	x	x	x	x	x	—	—
0	x	x	1	x	x	x	x	x	x	x	x	x	x	x	x	x	—	—
0	1	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	—	—
1	0	x	0	x	x	0	528 byte										SB0	SB1
1	0	x	0	x	x	1	528 byte										SB1	SB0
1	0	x	1	x	x	0	528 byte										SB0	
1	0	x	1	x	x	1	528 byte										SB1	
1	1	x	x	x	x	x	256 byte								0	0	Attribute Memory	

4.10. Internal ROM

The F2-16X has 8 Kbytes of internal ROM at address D000 0000₁₆ with a wraparound modulo 8 Kbytes up to DFFF FFFF₁₆. When the interrupt 4 input of the F2-16X is low (or open) at reset, the reset trap begins executing the internal boot ROM code at DFFF FFF8₁₆.

The internal ROM present on the F2-16X performs the following actions on reset when booting is done from ROM:

- ☐ The F2-16X processor is initialized.
- ☐ IO(3) is switched to output driving 0 (for Samsung Flashes) or 1 (for Hitachi Flashes), FCR bit 7 (Flash Select) is initialized according to the detected Flash type. After 50 µs delay for the stabilization of the voltage regulator, all Flashes are deselected and IO(2) (Flash Write Protect) is switched to output driving 1 so that Flash access is possible.
- ☐ The Busy flag is set in the ATA Status Register. The PCMCIA and ATA Registers are initialized to allow a PCMCIA boot if a power-on reset is detected.
- ☐ If the PWE# and PWAIT# pins were low at reset and still are, the F2-16X tries to boot from PCMCIA. Else, the F2-16X tries to boot from Flash 0. This involves a search of the Anchor Block and a load of the Main Program and Overlay sectors. If the Anchor Block is not found or if there is an uncorrectable error when loading the program, the F2-16X falls back to booting from PCMCIA. If the Anchor Block is found, a copy is stored in the sector buffer SB1. Then, a pre-boot routine at offset 01FC₁₆ in SB1 is called. After return, the F2-16X processor proceeds to load the Program and Overlay sectors from Flash 0 using the Anchor Block information in sector buffer SB1.
- ☐ For the PCMCIA boot, the F2-16X determines the device ID of flash chip 0 and stores this information in the cylinder high and low registers. Then, the F2-16X writes B8₁₆ into the ATA Error register and sets DRDY, DSC and ERR in the ATA Status register. The boot software on the host must then respond by writing the number of sectors (512 bytes) to boot into the ATA Sector Count register and 80₁₆ into the ATA Command register. The F2-16X then reads the specified number of sectors by setting DRDY, DRQ and DSC in the ATA Status register. The downloaded code is put into IRAM starting at address C000 0000₁₆.

5. Electrical Specifications

5.1. DC Characteristics

5.1.1. Absolute Maximum Ratings

Case temperature T_C under Bias:	0°C to $+85^{\circ}\text{C}$
extended temperature range on request	
Storage Temperature:	-65°C to $+150^{\circ}\text{C}$
Voltage on any Pin with respect to ground:	-0.5V to $V_{CC} + 0.5\text{V}$

5.1.2. D.C. Parameters

Supply Voltage V_{CC_P} and V_{CC_R} :	$5\text{V} \pm 0.25\text{V}$ or $3.3\text{V} \pm 0.30\text{V}$
Supply Voltage V_{CC_F} :	$3.3\text{V} \pm 0.30\text{V}$
Supply Voltage V_{CC_C} :	$2.5\text{V} \pm 0.25\text{V}$
Case Temperature T_{CASE} :	0°C to $+85^{\circ}\text{C}$

Symbol	Parameter	Min	Max	Units	Notes
V_{IL}	Input LOW Voltage	-0.3	+0.8	V	
V_{IH}	Input HIGH Voltage	2.0	$V_{CC}+0.3$	V	
V_{OL}	Output LOW Voltage		0.45	V	at 4mA
V_{OH}	Output HIGH Voltage	2.4		V	at 1mA
I_{CC}	Operating Current, $V_{CC_R}=5.0\text{V}$ Sleep mode Operating, 20 MHz Operating, 40 MHz		0.2 ** **	mA mA mA	
I_{CC}	Operating Current, $V_{CC_R}=3.3\text{V}$ Sleep mode Operating, 20 MHz Operating, 40 MHz		0.2 ** **	mA mA mA	
I_{LI}	Input Leakage Current		± 10	μA	
I_{LO}	Output Leakage Current		± 10	μA	
$C_{I/O}$	Input/output Capacitance		10	pF	

Table 2: DC Characteristics

5.2. AC Characteristics

The AC Characteristics reference the timing diagrams of the PCMCIA PC Card Standard and the symbols in these timing diagrams. The AC characteristics are valid for a supply voltage V_{CC} of $5V \pm 10\%$ or $3.3V \pm 5\%$.

5.2.1. Attribute Memory Read and Write AC Characteristics

Symbol	Parameter	Min	Max	Units
tcR	Read cycle time	250		ns
ta(A)	Address access time		250	ns
ta(CE)	Card Enable access time		250	ns
ta(OE)	Output Enable access time		125	ns
tdis(CE)	Output disable time from CE		100	ns
tdis(OE)	Output disable time from OE		100	ns
ten(CE)	Output enable time from CE	5		ns
ten(OE)	Output enable time from OE	5		ns
tv(A)	Data valid time from address change	0		ns
tsu(A)	Address setup time	30		ns
th(A)	Address hold time	20		ns
tsu(CE)	Card Enable setup time	0		ns
th(CE)	Card Enable hold time	20		ns
tcW	Write cycle time	250		ns
tw(WE)	Write pulse time	150		ns
tsu(A-WEH)	Address setup time for WE	180		ns
tsu(CE-WEH)	Card Enable setup time for WE	180		ns
tsu(D-WEH)	Data setup time for WE	80		ns
th(D)	Data hold time	30		ns
tdis(WE)	Output disable time from WE		100	ns
ten(WE)	Output enable time from WE	5		ns
tsu(OE-WE)	Output Enable setup time for WE	10		ns
th(OE-WE)	Output Enable hold time from WE	10		ns

Table 3: Attribute Memory Read and Write AC Characteristics

5.2.2. Common Memory Read and Write AC Characteristics

Symbol	Parameter	Min	Max	Units
tcR	Read cycle time	150		ns
ta(A)	Address access time		150	ns
ta(CE)	Card Enable access time		150	ns
ta(OE)	Output Enable access time		75	ns
tdis(CE)	Output disable time from CE		75	ns
tdis(OE)	Output disable time from OE		75	ns
ten(CE)	Output enable time from CE	5		ns
ten(OE)	Output enable time from OE	5		ns
tv(A)	Data valid time from address change	0		ns
tsu(A)	Address setup time	20		ns
th(A)	Address hold time	20		ns
tsu(CE)	Card Enable setup time	0		ns
th(CE)	Card Enable hold time	20		ns
tcW	Write cycle time	150		ns
tw(WE)	Write pulse time	80		ns
tsu(A-WEH)	Address setup time for WE	100		ns
tsu(CE-WEH)	Card Enable setup time for WE	100		ns
tsu(D-WEH)	Data setup time for WE	50		ns
th(D)	Data hold time	20		ns
trec(WE)	Write recover time	20		ns
tdis(WE)	Output disable time from WE		75	ns
ten(WE)	Output enable time from WE	5		ns
tsu(OE-WE)	Output Enable setup time for WE	10		ns
th(OE-WE)	Output Enable hold time from WE	10		ns

Table 4: Common memory Read and Write AC Characteristics

5.2.3. I/O Access Read and Write AC Characteristics

Symbol	Parameter	Min	Max	Units
td(IORD)	Data delay after IORD		100	ns
th(IORD)	Data hold following IORD	0		ns
tw(IORD)	IORD pulse width	165		ns
tsuA(IORD)	Address setup time for IORD	70		ns
thA(IORD)	Address hold time from IORD	20		ns
tsuCE(IORD)	Card Enable setup time for IORD	5		ns
thCE(IORD)	Card Enable hold time from IORD	20		ns
tsuREG(IORD)	REG setup time for IORD	5		ns
thREG(IORD)	REG hold time from IORD	0		ns
tdfINP(IORD)	INPACK delay falling from IORD	0	45	ns
tdrINP(IORD)	INPACK delay rising from IORD		45	ns
tdfIO16(IORD)	IOIS16 delay falling from address		35	ns
tdrIO16(IORD)	IOIS16 delay rising from address		35	ns
tsu(IOWR)	Data setup time for IOWR	60		ns
th(IOWR)	Data hold time from IOWR	30		ns
tw(IOWR)	IOWR pulse width	165		ns
tsuA(IOWR)	Address setup time for IOWR	70		ns
thA(IOWR)	Address hold time from IOWR	20		ns
tsuCE(IOWR)	Card Enable setup time for IOWR	5		ns
thCE(IOWR)	Card Enable hold time from IOWR	20		ns
tsuREG(IOWR)	REG setup time for IOWR	5		ns
thREG(IOWR)	REG hold time from IOWR	0		ns

Table 5: I/O Access Read and Write AC Characteristics

5.2.4. True-IDE Mode I/O Access Read and Write AC Characteristics

Symbol	Parameter	Min	Max	Units
tcR	Cycle time	120		ns
tsuA	Address setup time for IORD/IOWR	25		ns
thA	Address hold time from IORD/IOWR	10		ns
tw	IORD/IOWR pulse width	70		ns
trec	IORD/IOWR recovery time	25		ns
tsuD(IORD)	Data setup time for IORD	20		ns
thD(IORD)	Data hold following IORD	5		ns
tdis(IORD)	Output disable time from IORD		30	ns
tsuD(IOWR)	Data setup time for IOWR	20		ns
thD(IOWR)	Data hold following IOWR	10		ns

Table 6: True-IDE Mode I/O Access Read and Write AC Characteristics

5.2.5. Flash Memory Interface AC Characteristics, Samsung Type

The AC Characteristics for the flash memory interface are based on a F2-16X processor clock speed of 20 MHz.

Symbol	Parameter	Min	Max	Units
tCLS	CLE setup time	50		ns
tCLH	CLE hold time	20		ns
tCS	CE setup time	50		ns
tCH	CE hold time	50		ns
tWP	WE pulse width	25		ns
tALS	ALE setup time	50		ns
tALH	ALE hold time	20		ns
tDS	Data Setup time	25		ns
tDH	Data hold time	20		ns
tWC	Write cycle time	50		ns
tWH	WE high hold time	20		ns
tRP	RE pulse width	30		ns
tRC	Read cycle time	50		ns
tREA	RE access time	35		ns
tREH	RE high hold time	15		ns
tCEH	CE high hold time	200		ns
tWHR	WE high to RE low	100		ns

Table 7: AC Characteristics for Samsung Type flash memory

5.2.6. Flash Memory Interface AC Characteristics, Hitachi Type

The AC Characteristics for the flash memory interface are based on a F2-16X processor clock speed of 18 MHz.

Symbol	Parameter	Min	Max	Units
tCWC	Write cycle time	150		Ns
tSCC	Serial clock cycle time	50		Ns
tWP	Write pulse time	90		Ns
tWPH	Write pulse high time	50		Ns
tAS	Address setup time	120		Ns
tAH	Address hold time	20		Ns
tDS	Data setup time for WE	120		Ns
tDH	Data hold time from WE	20		Ns
tSP	SC pulse width	20		Ns
tSPL	SC pulse low time	20		Ns
tCDS	CDE setup time for WE	20		Ns
tCDH	CDE hold time for WE	20		Ns
tCPH	CE pulse high time	200		Ns
tDS	Data setup time for SC	20		Ns
tDH	Data hold time from SC	30		ns

Table 8: AC Characteristics for Hitachi Type flash memory



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